

#### SUBMINIATURE SOLID STATE LAMP

KM-27SURC-08

HYPER RED

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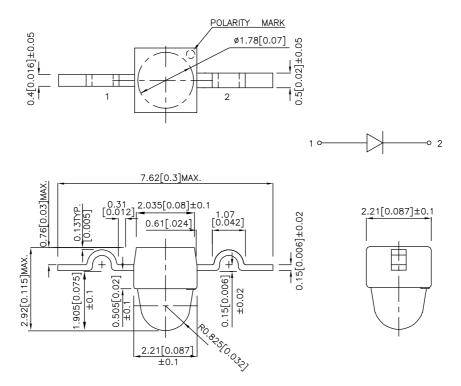
#### **Features**

- •SUBMINIATURE PACKAGE.
- •WIDE VIEWING ANGLE.
- •YOKE LEAD.
- •LONG LIFE-SOLID STATE RELIABILITY.
- •LOW PACKAGE PROFILE.
- ●PACKAGE: 1000PCS / REEL.
- •Rohs Compliant.

#### **Description**

The Hyper Red source color devices are made with DH InGaAIP on GaAs substrate Light Emitting Diode.

### **Package Dimensions**



#### Notes:

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is ±0.25(0.01") unless otherwise noted.
- $\ensuremath{\mathsf{3}}.$  Lead spacing is measured where the leads emerge from the package.
- 4. Specifications are subject to change without notice.

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APPROVED: J. Lu CHECKED: Allen Liu DRAWN: Y.W.WANG

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#### **Selection Guide**

Part No.	Dice	Lens Type	Iv (mcd) @ 20mA		Viewing Angle
			Min.	Тур.	201/2
KM-27SURC-08	HYPER RED (InGaAIP)	WATER CLEAR	280	1000	20°

Note:

### Electrical / Optical Characteristics at Ta=25°C

Symbol	Parameter	Device	Тур.	Max.	Units	Test Conditions
λpeak	Peak Wavelength	Hyper Red	640		nm	IF=20mA
λD	Dominant Wavelength	Hyper Red	628		nm	IF=20mA
Δλ1/2	Spectral Line Half-width	Hyper Red	27		nm	IF=20mA
С	Capacitance	Hyper Red	45		pF	VF=0V;f=1MHz
VF	Forward Voltage	Hyper Red	1.9	2.5	V	I=20mA
lr	Reverse Current	Hyper Red		10	uA	VR = 5V

### Absolute Maximum Ratings at Ta=25°C

Parameter	Hyper Red	Units
Power dissipation	170	mW
DC Forward Current	30	mA
Peak Forward Current [1]	185	mA
Reverse Voltage	5	V
Operating / Storage Temperature	-40°C To +85°C	<u>.</u>

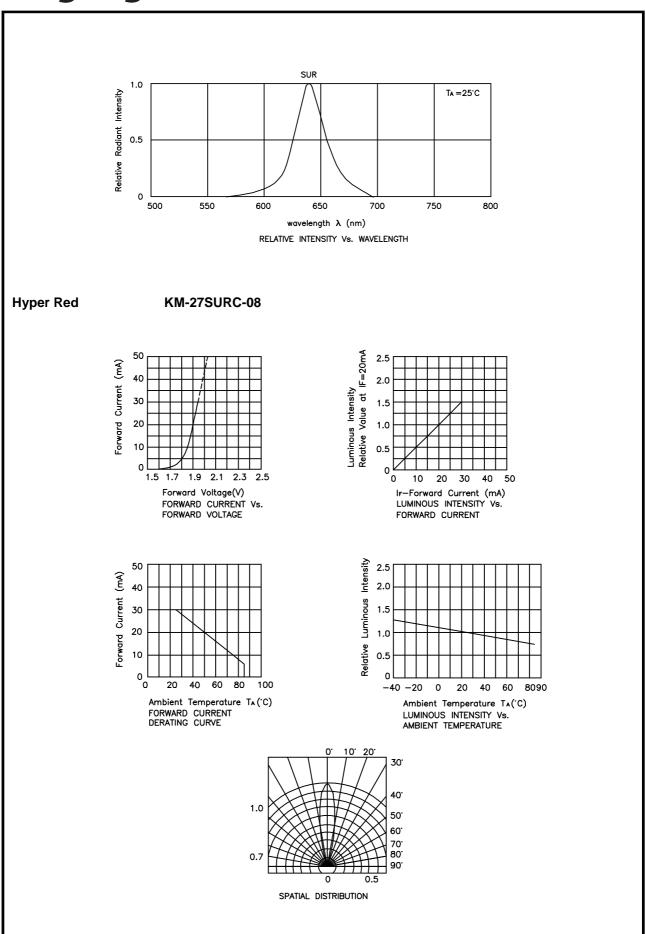
Note:

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 $<sup>1. \</sup>theta 1/2$  is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.

<sup>1. 1/10</sup> Duty Cycle, 0.1ms Pulse Width.

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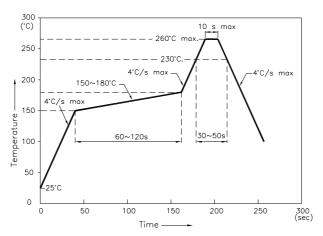
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### **KM-27SURC-08**

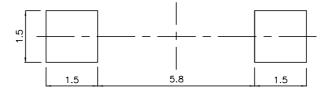
Reflow Soldering Profile For Lead-free SMT Process.



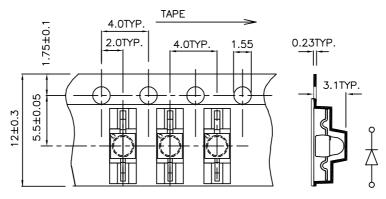
NOTES:

- We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
- 2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.

## Recommended Soldering Pattern (Units: mm)



## Tape Specifications (Units: mm)



#### Remarks

If special sorting is required (e.g. binning based on forward voltage, luminous intensity, or wavelength), the typical accuracy of the sorting process is as follows:

- 1. Wavelength: +/-1nm
- 2. Luminous Intensity: +/-15%
- 3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.

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